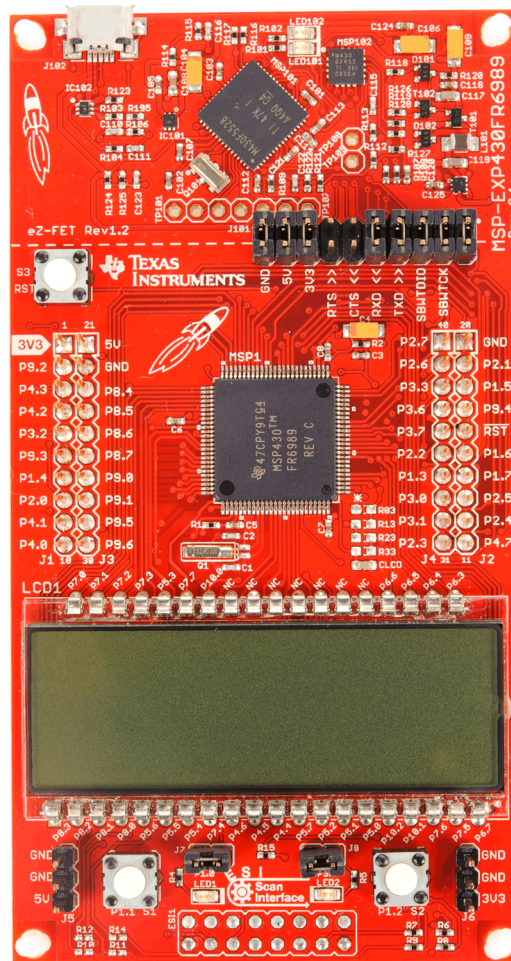


# **MSP430FR6989 LaunchPad™ Development Kit (MSP-EXP430FR6989)**

The [MSP-EXP430FR6989](#) LaunchPad™ Development Kit is an easy-to-use evaluation module (EVM) for the [MSP430FR6989](#) microcontroller (MCU). It contains everything needed to start developing on the ultra-low-power MSP430FRx FRAM microcontroller platform, including on-board emulation for programming, debugging, and energy measurements.



**Figure 1. MSP-EXP430FR6989 LaunchPad Development Kit**

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## 1 Getting Started

### 1.1 Introduction

The MSP-EXP430FR6989 LaunchPad Development Kit is an easy-to-use Evaluation Module (EVM) for the MSP40FR6989 microcontroller (MCU). It contains everything needed to start developing on the ultra-low-power MSP430FRx FRAM microcontroller platform, including on-board emulation for programming, debugging and energy measurements. The board features on-board buttons and LEDs for quick integration of a simple user interface as well as a Liquid Crystal Display (LCD) display which showcases the integrated driver that can drive up to 320 segments. It also offers direct access to the Extended Scan Interface, which is a dual analog front-end (AFE) created for low-power rotation detection. The MSP430FR6989 device features ultra-low power consumption, 128KB of embedded ferroelectric random access memory (FRAM), a nonvolatile memory known for its ultra-low power, high endurance, and high-speed write access.

Rapid prototyping is simplified by the 40-pin BoosterPack™ Plug-in Module headers, which support a wide range of available BoosterPack modules. You can quickly add features like wireless connectivity, graphical displays, environmental sensing, and much more. Design your own BoosterPack or choose among many already available from TI and third party developers.

The out-of-box provided with the MSP-EXP430FR6989 LaunchPad features the on-board segmented display and offers two operating modes. Stopwatch Mode can run a timer for up to 24 hours, or alternatively operate split time, where the display can be frozen and the stopwatch continues running in the background. The second mode provides a simple thermometer application using the on-chip temperature sensor. The temperature is displayed on the LCD and can be shown in degrees Fahrenheit or Celsius.

Free software development tools are also available, such as TI's Eclipse-based Code Composer Studio (CCS) and IAR Embedded Workbench. Both of these IDEs support EnergyTrace++™ technology for real-time power profiling and debugging when paired with the MSP430FR6989 LaunchPad. More information about the LaunchPad, the supported BoosterPack modules and available resources can be found at TI's LaunchPad portal.

### 1.2 Key Features

- MSP ULP FRAM technology based MSP430FR6989 16-bit MCU
- EnergyTrace++ technology available for ultra-low-power debugging
- 40 pin LaunchPad standard leveraging the BoosterPack ecosystem
- Onboard eZ-FET emulation
- Two buttons and two LEDs for user interaction
- Segmented LCD
- Pins for direct access to the Extended Scan Interface

### 1.3 What's Included

#### 1.3.1 Kit Contents

- 1x MSP-EXP430FR6989 LaunchPad Development Kit
- 1x Micro USB cable
- 1x Quick Start Guide

#### 1.3.2 Software Examples

- Out-of-Box Software
- Blink LED

## 1.4 First Steps: Out-of-Box Experience

An easy way to get familiar with the EVM is by using its preprogrammed out-of-box code. This code demonstrates some key features from a user level.

### 1.4.1 Connecting to the Computer

Connect the LaunchPad using the included USB cable to a computer. A green power LED should illuminate. For proper operation, drivers are needed. TI recommends installing these driver by installing an IDE such as TI's CCS or IAR EW430. Drivers are also available at <http://www.ti.com/MSPdrivers>.

### 1.4.2 Running the Out-of-Box Demo

When connected to your computer, the LaunchPad powers up and displays a greeting message on the LCD. Press and hold the S1 and S2 buttons simultaneously to select a new mode. See Section 3 for detailed explanations of each mode.

#### 1.4.2.1 Stopwatch Mode

This mode provides a simple stopwatch application. It supports split time, where the display freezes while the stopwatch continues running in the background.

Timer Stopped:

- S1 : Start time
- S2 : Reset time

Timer Running:

- S1 : Stop time
- S2 : Split time (lap time)

#### 1.4.2.2 Temperature Mode

This mode provides a simple thermometer application. Using the on-chip temperature sensor, the temperature is displayed on the LCD.

- S1 : Pause current temperature
- S2 : Toggle temperature between °F and °C

## 1.5 Next Steps: Looking Into the Provided Code

After the EVM features have been explored, the fun can begin. It's time to open an integrated development environment and start editing the code examples. Refer to [Section 4](#) for available IDEs and where to download them.

The quickest way to get started using the LaunchPad is to use TI's Cloud Development Tools, <http://dev.ti.com>. The cloud-based Resource Explorer provides access to all of the examples and resources in MSPWare. Code Composer Studio Cloud is a simple Cloud-based IDE that enables developing and running applications on the LaunchPad.

The out-of-box source code and more code examples are provided for download at <http://www.ti.com/tool/msp-exp430fr6989>. Code is licensed under BSD, and TI encourages reuse and modifications to fit specific needs.

[Section 3](#) describes all functions in detail and provides a project structure to help familiarize you with the code.

With the onboard eZ-FET emulator debugging and downloading new code is simple. A USB connection between the EVM and a PC through the provided USB cable is all that is needed.

## 2 Hardware

Figure 2 shows an overview of the MSP-EXP430FR6989 hardware.

# MSP-EXP430FR6989 Overview

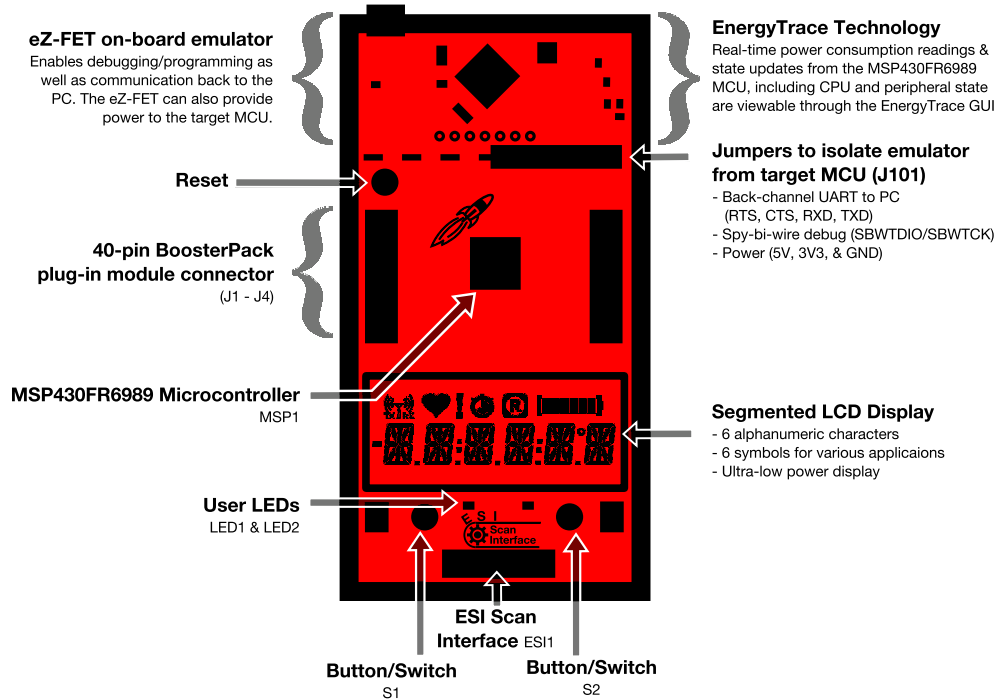
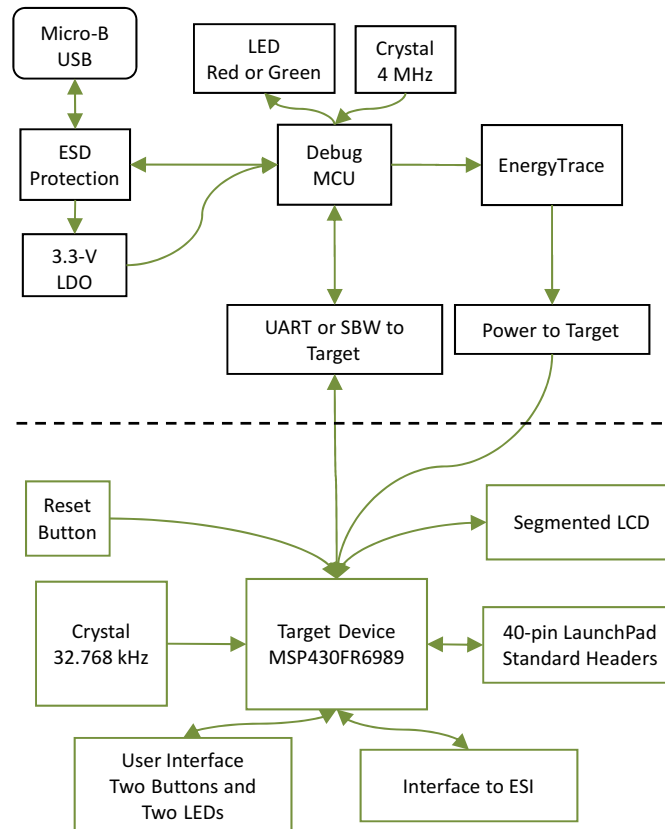


Figure 2. MSP-EXP430FR6989 Overview

## 2.1 Block Diagram

Figure 3 shows the block diagram.



**Figure 3. MSP-EXP430FR6989 Block Diagram**

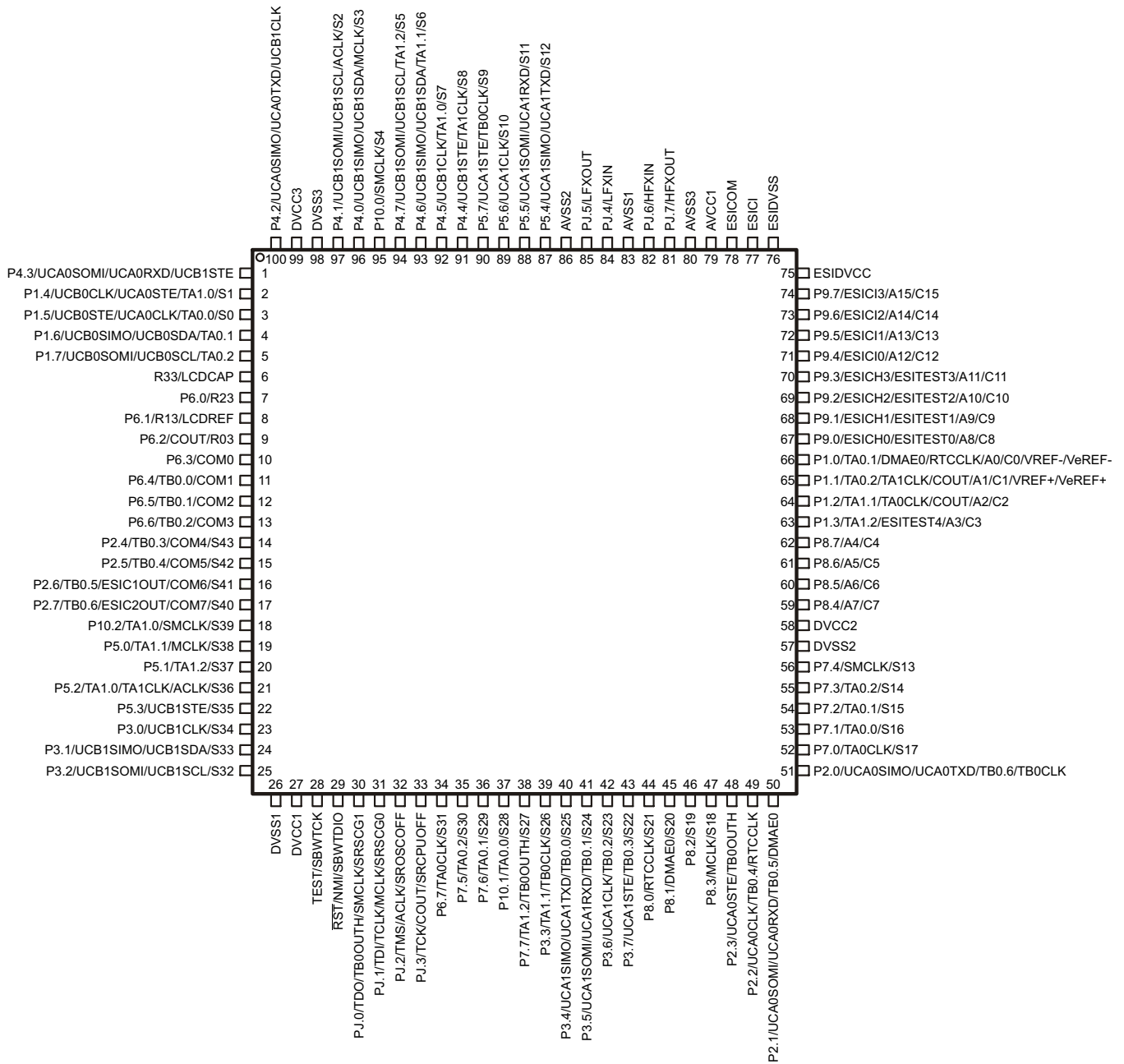
## 2.2 Hardware Features

### 2.2.1 MSP430FR6989

The MSP430FR6989 is the next device in TI's new ULP FRAM technology platform. FRAM is a cutting edge memory technology, combining the best features of flash and RAM into one nonvolatile memory.

Device features include:

- 1.8-V to 3.6-V operation
- 16-bit RISC architecture up to 16-MHz system clock and 8-MHz FRAM access
- 128KB of nonvolatile FRAM
- 100  $\mu$ A/MHz active mode and 350 nA standby with RTC and 3.7-pF crystal
- Certified ULPBench score of 109
- 320-segment LCD controller
- Extended Scan Interface
- 16-channel 12-bit ADC
- Comparator
- Five Timers
- Direct memory access
- 256-bit AES
- 83 GPIOs



On devices with UART BSL: P2.0: BSLTX; P2.1: BSLRX

On devices with I<sup>2</sup>C BSL: P1.6: BSLSDA; P1.7: BSLSCL

Figure 4. MSP430FR6989IPZ Pinout

### 2.2.2 eZ-FET Onboard Emulator With EnergyTrace™ Technology

To keep development easy and cost effective, TI's LaunchPad Development Kits integrate an onboard emulator, which eliminates the need for expensive programmers. The MSP-EXP430FR6989 has the eZ-FET emulator (see [Figure 5](#)), which is a simple and low-cost debugger that supports all MSP430 device derivatives.

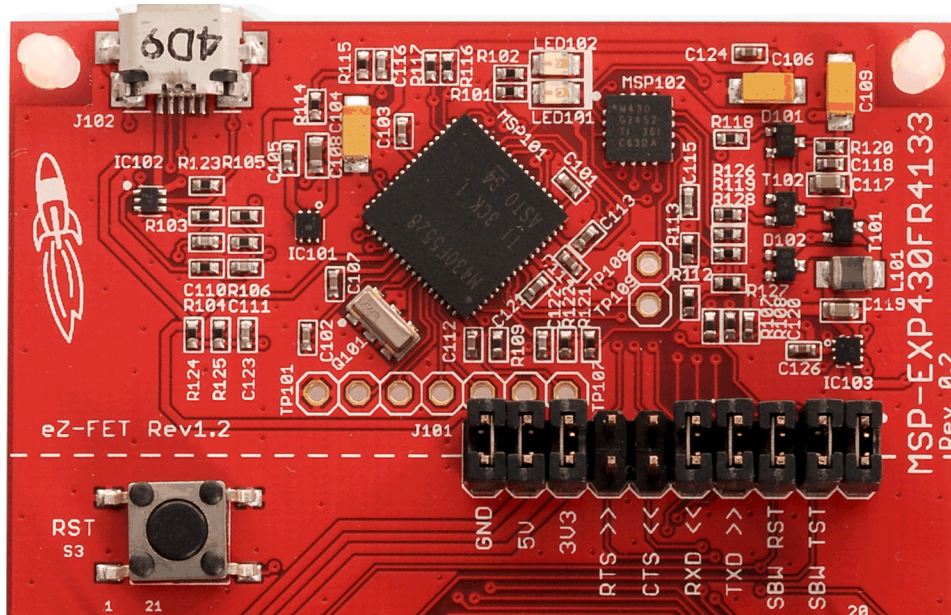


Figure 5. eZ-FET Emulator

The MSP-EXP430FR6989 LaunchPad features full EnergyTrace++ technology. The EnergyTrace functionality varies across the MSP portfolio, shown in [Table 1](#).

Table 1. EnergyTrace Technology

| Features                    | EnergyTrace™ Technology | EnergyTrace++™ Technology    |
|-----------------------------|-------------------------|------------------------------|
| Current Monitoring          | Yes                     | Yes                          |
| CPU State                   | No                      | Yes                          |
| Peripheral and System State | No                      | Yes                          |
| Devices Supported           | All MSP430 MCUs         | MSP430FR59xx and FR69xx MCUs |
| Development Tool Required   | MSP-FET or eZ-FET       | MSP-FET or eZ-FET            |

The eZ-FET also provides a "backchannel" UART-over-USB connection with the host, which can be very useful during debugging and for easy communication with a PC. The provided UART supports hardware flow control (RTS and CTS), although by default these signals are not connected to the target.

In [Figure 5](#), the dotted line through J101 divides the eZ-FET emulator from the target area. The signals that cross this line can be disconnected by jumpers on J101, the isolation jumper block. More details on the isolation jumper block are in [Section 2.2.3](#).

The eZ-FET hardware can be found in the schematics in [Section 6](#) and in the [MSP-EXP430FR6989 Hardware Design Files](#). The software and more information about the debugger can be found on the [eZ-FET wiki](#).



### 2.2.3 Emulator Connection: Isolation Jumper Block

The isolation jumper block at jumper J101 connects or disconnects signals that cross from the eZ-FET domain into the MSP430FR6989 target domain. This includes eZ-FET Spy-Bi-Wire signals, application UART signals, and 3.3-V and 5-V power (see [Table 2](#) and [Figure 6](#)).

Reasons to open these connections:

- To remove any and all influence from the eZ-FET emulator for high accuracy target power measurements
- To control 3-V and 5-V power flow between the eZ-FET and target domains
- To expose the target MCU pins for other use than onboard debugging and application UART communication
- To expose the programming and UART interface of the eZ-FET so that it can be used for devices other than the onboard MCU.

**Table 2. Isolation Block Connections**

| Jumper  | Description  |
|---------|--|
| GND     | Ground   |
| 5V      | 5-V VBUS from USB  |
| 3V3     | 3.3-V rail, derived from VBUS in the eZ-FET domain   |
| RTS >>  | Backchannel UART: Ready-To-Send, for hardware flow control. The target can use this to indicate whether it is ready to receive data from the host PC. The arrows indicate the direction of the signal.     |
| CTS <<  | Backchannel UART: Clear-To-Send, for hardware flow control. The host PC (through the emulator) uses this to indicate whether it is ready to receive data. The arrows indicate the direction of the signal. |
| RXD <<  | Backchannel UART: The target FR6989 receives data through this signal. The arrows indicate the direction of the signal.  |
| TXD >>  | Backchannel UART: The target FR6989 sends data through this signal. The arrows indicate the direction of the signal.   |
| SBW RST | Spy-Bi-Wire emulation: SBWTDIO data signal. This pin also functions as the RST signal (active low).  |
| SBW TST | Spy-Bi-Wire emulation: SBWTCK clock signal. This pin also functions as the TST signal.   |

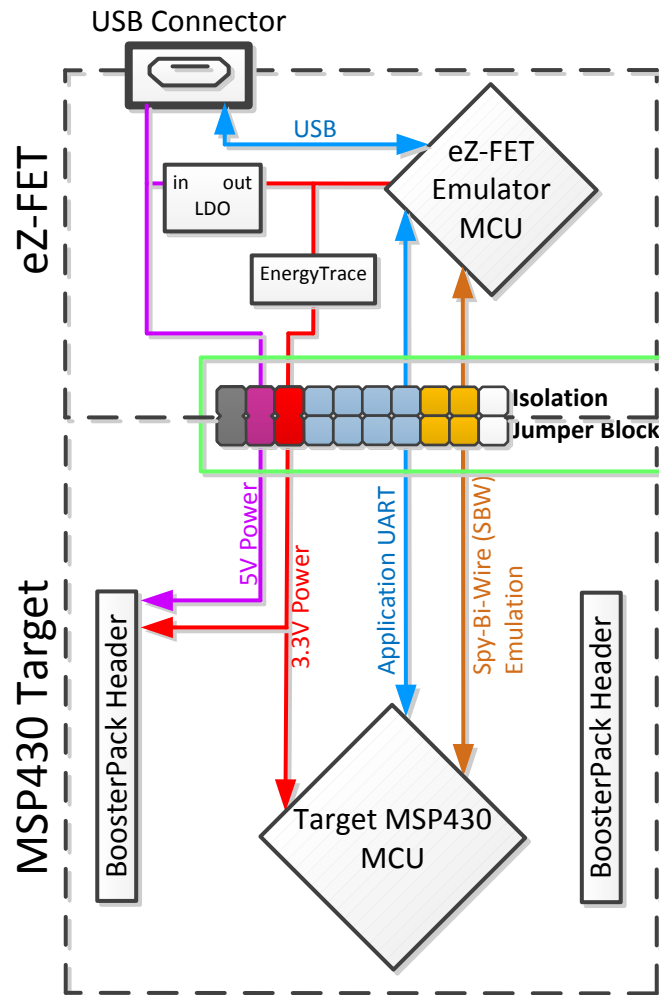


Figure 6. eZ-FET Isolation Jumper Block Diagram

#### 2.2.4 Application (or "Backchannel") UART

The backchannel UART allows communication with the USB host that is not part of the target application's main functionality. This is very useful during development, and also provides a communication channel to the PC host side. This can be used to create graphical user interfaces (GUIs) and other programs on the PC that communicate with the LaunchPad.

Figure 7 shows the pathway of the backchannel UART. The backchannel UART is the UART on eUSCI\_A1. This UART channel is separate from the UART on the 20-pin BoosterPack connector (eUSCI\_A0).

On the host side, a virtual COM port for the application backchannel UART is generated when the LaunchPad enumerates on the host. You can use any PC application that interfaces with COM ports, including terminal applications like Hyperterminal or Docklight, to open this port and communicate with the target application. You need to identify the COM port for the backchannel. On Windows PCs, Device Manager can assist.

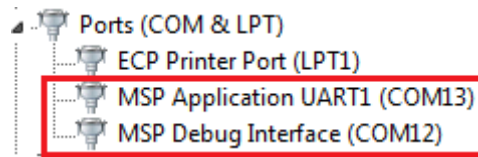


Figure 7. Application Backchannel UART in Device Manager

The backchannel UART is the "MSP Application UART1" port. In this case, Figure 7 shows COM13, but this port can vary from one host PC to the next. After you identify the correct COM port, configure it in your host application according to its documentation. You can then open the port and begin communication to it from the host.

On the target MSP430FR6989 side, the backchannel is connected to the eUSCI\_A1 module. The eZ-FET has a configurable baud rate; therefore, it is important that the PC application configures the baud rate to be the same as what is configured on the eUSCI\_A1.

The eZ-FET also supports hardware flow control, if desired. Hardware flow control (CTS and RTS handshaking) allows the target MSP430FR6989 and the emulator to tell each other to wait before sending more data. At low baud rates and with simple target applications, flow control may not be necessary. Applications with higher baud rates and more interrupts to service have a higher likelihood that they will not be able to read the eUSCI\_A1 RXBUF register in time, before the next byte arrives. If this happens, the eUSCI\_A1 UCA1STATW register reports an overrun error.

## 2.2.5 Special Features

### 2.2.5.1 Liquid Crystal Display (LCD)

The MSP430FR6989 LaunchPad features an on-board LCD! This LCD is driven by the internal LCD driver on the MSP430FR6989 device.

There are many available LCD segments, including six full alpha-numeric numbers or letters in addition to several symbols at the top for various modes or applications. Figure 8 shows the layout of the LCD, and Table 3 and Table 4 list the mapping of these segments.

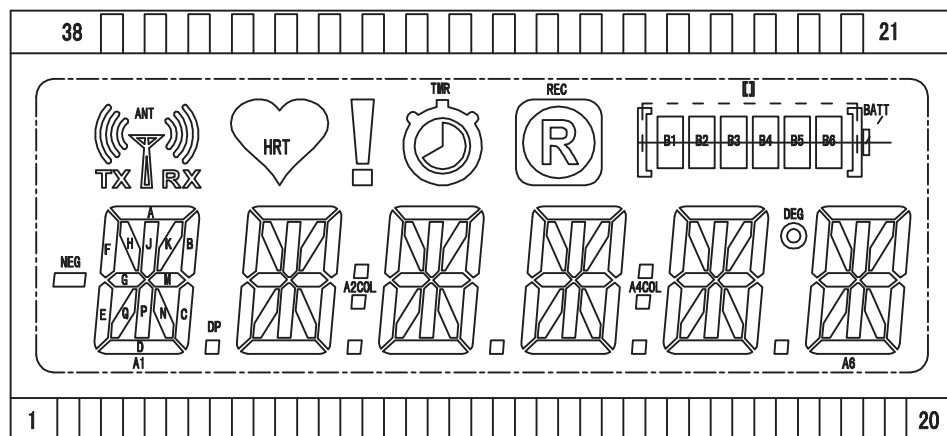


Figure 8. LCD Segment Layout

**Table 3. LCD FH-1138P Segment Mapping**

| PIN | COM3 | COM2  | COM1 | COM0 |
|-----|------|-------|------|------|
| 1   | A1E  | A1F   | A1G  | A1M  |
| 2   | A1A  | A1B   | A1C  | A1D  |
| 3   | A1Q  | NEG   | A1N  | A1DP |
| 4   | A1H  | A1J   | A1K  | A1P  |
| 5   | A2E  | A2F   | A2G  | A2M  |
| 6   | A2A  | A2B   | A2C  | A2D  |
| 7   | A2Q  | A2COL | A2N  | A2DP |
| 8   | A2H  | A2J   | A2K  | A2P  |
| 9   | A3R  | A3F   | A3G  | A3M  |
| 10  | A3A  | A3B   | A3C  | A3D  |
| 11  | A3Q  | ANT   | A3N  | A3DP |
| 12  | A3H  | A3J   | A3K  | A3P  |
| 13  | A4R  | A4F   | A4G  | A4M  |
| 14  | A4A  | A4B   | A4C  | A4D  |
| 15  | A4Q  | A4COL | A4N  | A4DP |
| 16  | A4H  | A4J   | A4K  | A4P  |
| 17  | A5E  | A5F   | A5G  | A5M  |
| 18  | A5A  | A5B   | A5C  | A5D  |
| 19  | A5Q  | DEG   | A5N  | A5DP |
| 20  | A5H  | A5J   | A5K  | A5P  |
| 21  | COM3 | -     | -    | -    |
| 22  | -    | COM2  | -    | -    |
| 23  | -    | -     | COM1 | -    |
| 24  | -    | -     | -    | COM0 |
| 25  | -    | -     | -    | -    |
| 26  | -    | -     | -    | -    |
| 27  | -    | -     | -    | -    |
| 28  | -    | -     | -    | -    |
| 29  | -    | -     | -    | -    |
| 30  | -    | -     | -    | -    |
| 31  | -    | -     | -    | -    |
| 32  | TMR  | HRT   | REC  | !    |
| 33  | B6   | B4    | B2   | BATT |
| 34  | B5   | B3    | B1   | []   |
| 35  | A6E  | A6F   | A6G  | A6M  |
| 36  | A6A  | A6B   | A6C  | A6D  |
| 37  | A6Q  | TX    | A6N  | RX   |
| 38  | A6H  | A6J   | A6K  | A6P  |

**Table 4. LCD-to-MSP Connections**

| LCDMEM | Port Pin | FR6989 Pin | LCD Pin | COM3 | COM2 | COM1 | COM0 | Port Pin | FR6989 Pin | LCD Pin | COM3 | COM2  | COM1 | COM0 |
|--------|----------|------------|---------|------|------|------|------|----------|------------|---------|------|-------|------|------|
| LCDM22 | P2.4     | S43        |         |      |      |      |      | P2.5     | S42        |         |      |       |      |      |
| LCDM21 | P2.6     | S41        |         |      |      |      |      | P2.7     | S40        |         |      |       |      |      |
| LCDM20 | P10.2    | S39        | 16      | A4H  | A4J  | A4K  | A4P  | P5.0     | S38        | 15      | A4Q  | A4COL | A4N  | A4DP |
| LCDM19 | P5.1     | S37        | 14      | A4A  | A4B  | A4C  | A4D  | P5.2     | S36        | 13      | A4R  | A4F   | A4G  | A4M  |
| LCDM18 | P5.3     | S35        | 34      | B5   | B3   | B1   | []   | P3.0     | S34        |         |      |       |      |      |
| LCDM17 | P3.1     | S33        |         |      |      |      |      | P3.2     | S32        |         |      |       |      |      |
| LCDM16 | P6.7     | S31        | 20      | A5H  | A5J  | A5K  | A5P  | P7.5     | S30        | 19      | A5Q  | DEG   | A5N  | A5DP |
| LCDM15 | P7.6     | S29        | 18      | A5A  | A5B  | A5C  | A5D  | P10.1    | S28        | 17      | A5E  | A5F   | A5G  | A5M  |
| LCDM14 | P7.7     | S27        | 33      | B6   | B4   | B2   | BATT | P3.3     | S26        |         |      |       |      |      |
| LCDM13 | P3.4     | S25        |         |      |      |      |      | P3.5     | S24        |         |      |       |      |      |
| LCDM12 | P3.6     | S23        |         |      |      |      |      | P3.7     | S22        |         |      |       |      |      |
| LCDM11 | P8.0     | S21        | 4       | A1H  | A1J  | A1K  | A1P  | P8.1     | S20        | 3       | A1Q  | NEG   | A1N  | A1DP |
| LCDM10 | P8.2     | S19        | 2       | A1A  | A1B  | A1C  | A1D  | P8.3     | S18        | 1       | A1E  | A1F   | A1G  | A1M  |
| LCDM9  | P7.0     | S17        | 38      | A6H  | A6J  | A6K  | A6P  | P7.1     | S16        | 37      | A6Q  | TX    | A6N  | RX   |
| LCDM8  | P7.2     | S15        | 36      | A6A  | A6B  | A6C  | A6D  | P7.3     | S14        | 35      | A6E  | A6F   | A6G  | A6M  |
| LCDM7  | P7.4     | S13        | 8       | A2H  | A2J  | A2K  | A2P  | P5.4     | S12        | 7       | A2Q  | A2COL | A2N  | A2DP |
| LCDM6  | P5.5     | S11        | 6       | A2A  | A2B  | A2C  | A2D  | P5.6     | S10        | 5       | A2E  | A2F   | A2G  | A2M  |
| LCDM5  | P5.7     | S9         | 12      | A3H  | A3J  | A3K  | A3P  | P4.4     | S8         | 11      | A3Q  | ANT   | A3N  | A3DP |
| LCDM4  | P4.5     | S7         | 10      | A3A  | A3B  | A3C  | A3D  | P4.6     | S6         | 9       | A3R  | A3F   | A3G  | A3M  |
| LCDM3  | P4.7     | S5         |         |      |      |      |      | P10.0    | S4         | 32      | TMR  | HRT   | REC  | !    |
| LCDM2  | P4.0     | S3         |         |      |      |      |      | P4.1     | S2         |         |      |       |      |      |
| LCDM1  | P1.4     | S1         |         |      |      |      |      | P1.5     | S0         |         |      |       |      |      |

### 2.2.5.2 Extended Scan Interface (ESI)

The MSP430FR6989 LaunchPad features pins to access the extended scan interface on the device. These pins are accessed on the through connector ESI1. Some of these pins are also connected to the BoosterPack header pins. For applications that use the ESI and a connected BoosterPack, be sure to check for any pin conflicts. Pins can be disconnected from the ESI header using the 0-Ω resistors R6 to R12, R14, and R15.

The ESI1 header matches the ESI access header on [EVM430-FR6989](#). This EVM is built to show off the ESI functionality more thoroughly. Any plugin modules from the EVM430-FR6989 can be reused on the MSP-EXP430FR6989 LaunchPad. Note that when populating the ESI1 header, it must be plugged in from the bottom side to match the EVM430-FR6989.

### 2.3 Power

The board was designed to accommodate various powering methods, including through the on-board eZ-FET as well as external or BoosterPack power.

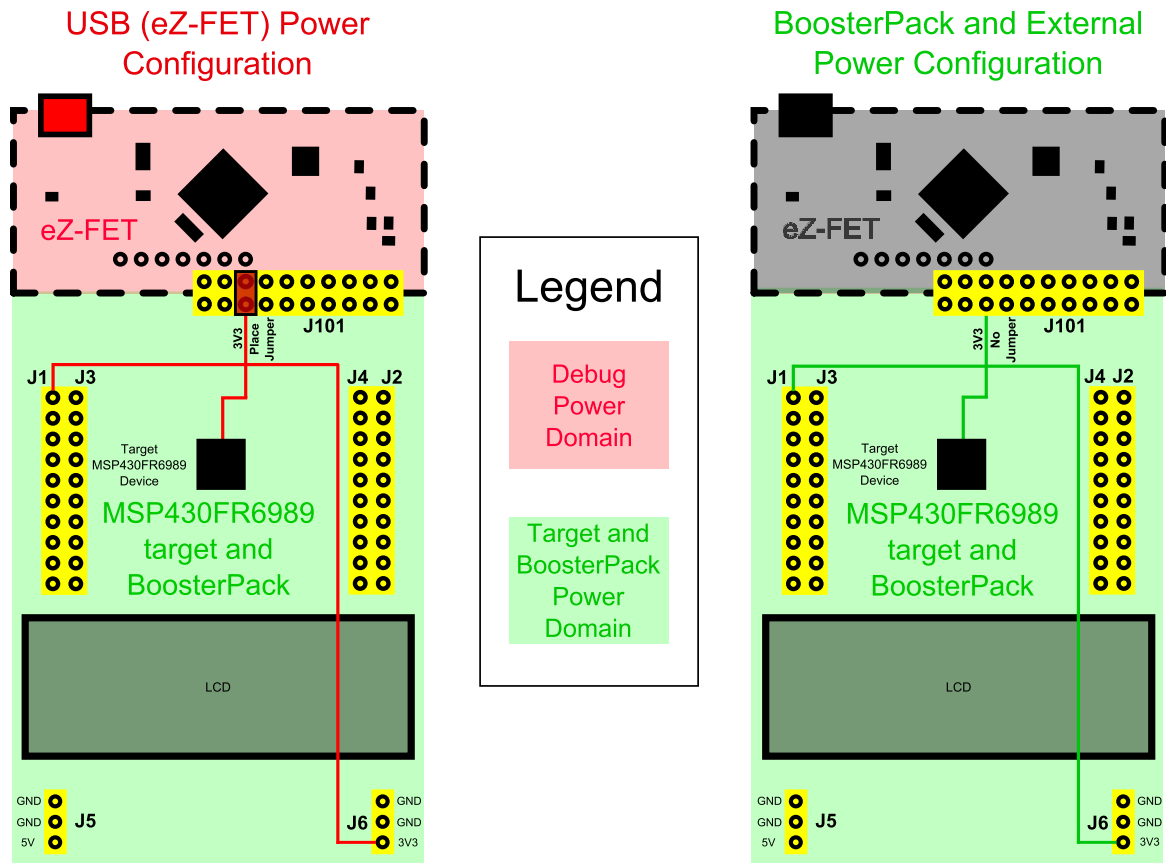


Figure 9. MSP-EXP430FR6989 Power Block Diagram

#### 2.3.1 eZ-FET USB Power

The most common power-supply scenario is from USB through the eZ-FET debugger. This provides 5-V power from the USB and also regulates this power rail to 3.3 V for eZ-FET operation and 3.3 V to the target side of the LaunchPad. Power from the eZ-FET is controlled by jumper J101. For 3.3 V, make sure that a jumper is connected across the J101 3V3 terminal.

#### 2.3.2 BoosterPack and External Power Supply

Header J6 is present on the board to supply external power directly. It is important to comply with the device voltage operation specifications when supplying external power. The MSP430FR6989 has an operating range of 1.8 V to 3.6 V. More information can be found in the [MSP430FR6989 device data sheet](#).

## 2.4 Measure MSP430 Current Draw

To measure the current draw of the MSP430FR6989 using a multi-meter, use the 3V3 jumper on the jumper isolation block. The current measured includes the target device and any current drawn through the BoosterPack headers.

To measure ultra-low power, follow these steps:

1. Remove the 3V3 jumper in the isolation block, and attach an ammeter across this jumper.
2. Consider the effect that the backchannel UART and any circuitry attached to the MSP430FR6989 may have on current draw. Consider disconnecting these at the isolation jumper block, or at least consider their current sinking and sourcing capability in the final measurement.
3. Make sure there are no floating inputs/outputs (I/Os). These cause unnecessary extra current draw. Every I/O should either be driven out or, if it is an input, should be pulled or driven to a high or low level.
4. Begin target execution.
5. Measure the current. Keep in mind that if the current levels are fluctuating, it may be difficult to get a stable measurement. It is easier to measure quiescent states.

Alternatively, EnergyTrace++ technology can be used to measure the same current, and see energy profiles through integrated GUI in CCS and IAR. EnergyTrace allows you to compare various current profiles and better optimize your energy performance!

## 2.5 Clocking

The MSP-EXP430FR6989 provides an external clock in addition to the internal clocks in the device.

- Y1: 32-kHz MicroCrystal crystal (MS3V)

The 32-kHz crystal allows for lower LPM3 sleep currents than do the other low-frequency clock sources. Therefore, the presence of the crystal allows the full range of low-power modes to be used.

The internal clocks in the device default to the following configuration:

- MCLK: DCO 1 MHz
- SMCLK: DCO 1 MHz
- ACLK: REFO 32.768 kHz

For more information about configuring internal clocks and using the external oscillators, see the [MSP430FR69xx Family User's Guide](#).

## 2.6 Using the eZ-FET Emulator with a Different Target

The eZ-FET emulator on the LaunchPad can interface to most MSP430 derivative devices, not just the on-board MSP430FR6989 target device.

To do this, disconnect every jumper in the isolation jumper block. This is necessary, because the emulator cannot connect to more than one target at a time over the Spy-Bi-Wire (SBW) connection.

Next, make sure the target board has proper connections for SBW. Note that to be compatible with SBW, the capacitor on RST/SBWDIO cannot be greater than 2.2 nF. The documentation for designing MSP430 JTAG interface circuitry is the [MSP430 Hardware Tools User's Guide](#).

Finally, wire together these signals from the emulator side of the isolation jumper block to the target hardware:

- 5 V (if 5 V is needed)
- 3.3 V
- GND
- SBWDIO
- SBWTCK
- TXD (if the UART backchannel is to be used)
- RXD (if the UART backchannel is to be used)

- CTS (if hardware flow control is to be used)
- RTS (if hardware flow control is to be used)

This wiring can be done either with jumper wires or by designing the board with a connector that plugs into the isolation jumper block.

## 2.7 **BoosterPack Pinout**

The LaunchPad adheres to the 40-pin LaunchPad pinout standard. A standard was created to aid compatibility between LaunchPad and BoosterPack tools across the TI ecosystem.

The 40-pin standard is compatible with the 20-pin standard that is used by other LaunchPad kits like the [MSP-EXP430FR4133](#). This allows some subset of functionality of 40-pin BoosterPack modules to be used with 20-pin LaunchPad kits.

While most BoosterPack modules are compliant with the standard, some are not. The MSP-EXP430FR6989 LaunchPad is compatible with all 40-pin BoosterPack modules that are compliant with the standard. If the reseller or owner of the BoosterPack does not explicitly indicate compatibility with the MSP-EXP430FR6989 LaunchPad, compare the schematic of the candidate BoosterPack with the LaunchPad to ensure compatibility. Keep in mind that sometimes conflicts can be resolved by changing the MSP430FR6989 device pin function configuration in software. More information about compatibility can also be found at <http://www.ti.com/launchpad>.

[Figure 10](#) shows the 40-pin pinout of the MSP430FR6989 LaunchPad.

Note that software configuration of the pin functions plays a role in compatibility. The LaunchPad side of the dashed line in [Figure 10](#) shows all of the functions for which the MSP430FR6989 device pins can be configured. This can also be seen in the MSP430FR6989 data sheet. The BoosterPack side of the dashed line shows the standard. The LaunchPad function whose color matches the BoosterPack function shows the specific software-configurable function by which the MSP430FR6989 LaunchPad adheres to the standard.



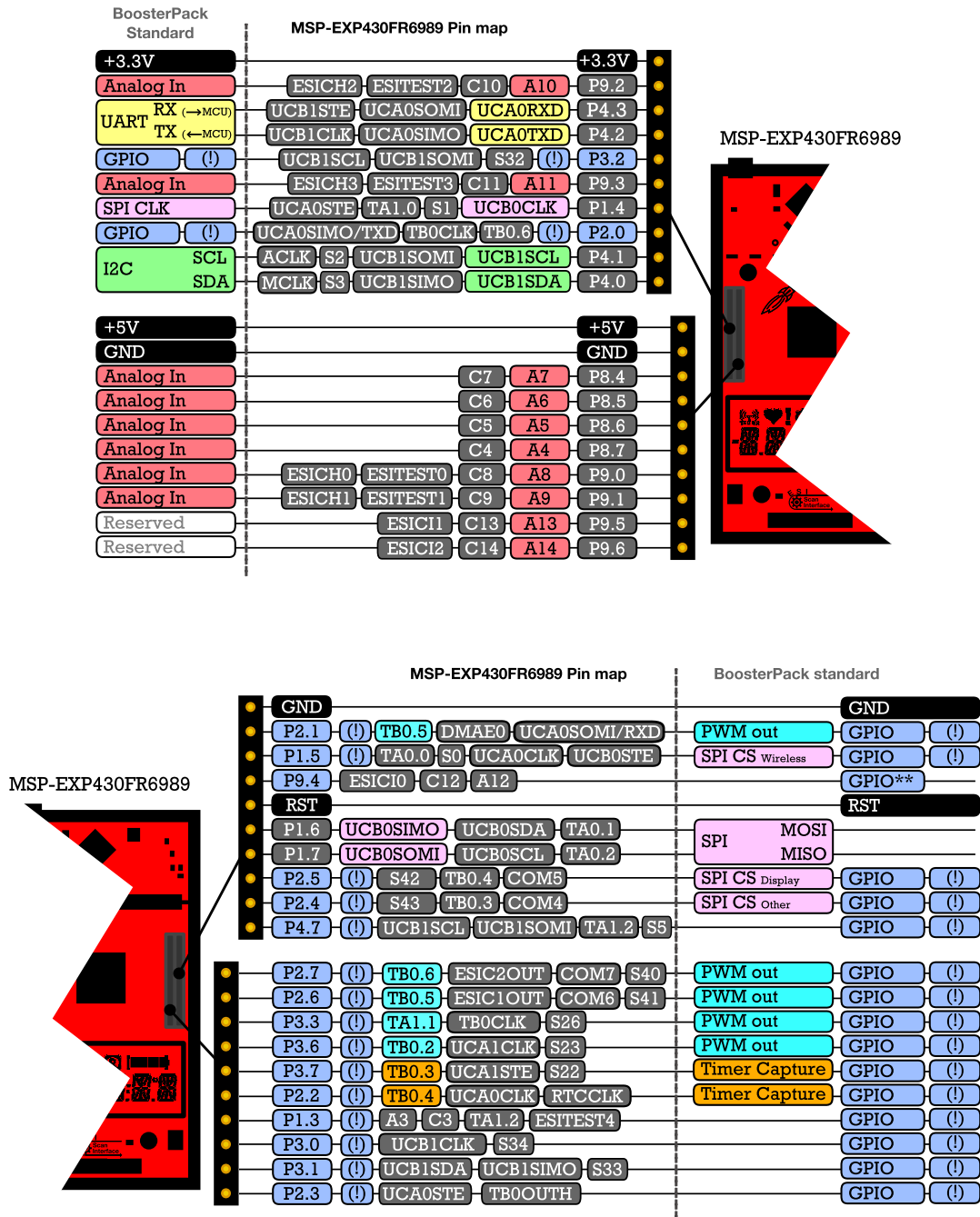


Figure 10. LaunchPad to BoosterPack Connector Pinout

## 2.8 Design Files

### 2.8.1 Hardware

Schematics can be found in [Section 6](#). All design files including schematics, layout, bill of materials (BOM), Gerber files, and documentation are available in the [MSP-EXP430FR6989 Hardware Design Files](#).

### 2.8.2 Software

All design files including TI-TXT object-code firmware images, software example projects, and documentation are available in the [MSP-EXP430FR6989 Software Examples](#).

## 2.9 Hardware Change log

**Table 5. Hardware Change Log**

| PCB Revision | Description     |
|--------------|-----------------|
| Rev 1.0      | Initial Release |

## 3 Software Examples

There are two software examples included with the MSP430FR6989 LaunchPad (see [Table 6](#)), which can be found in the [MSP-EXP430FR6989 Software Examples](#) and are also available in MSP430Ware.

**Table 6. Software Examples**

| Demo Name       | BoosterPack Required | Description   | More Details                |
|-----------------|----------------------|---|-----------------------------|
| OutOfBox_FR6989 | None                 | The out-of-box demo pre-programmed on the LaunchPad from the factory. Demonstrates features of MSP430FR6989 device. | <a href="#">Section 3.1</a> |
| BlinkLED_FR6989 | None                 | Blinks an LED on the LaunchPad at a fixed interval.   | <a href="#">Section 3.2</a> |

To use any of the software examples with the LaunchPad, you must have an integrated development environment (IDE) that supports the MSP430FR6989 device.

**Table 7. IDE Minimum Requirements for MSP-EXP430FR6989**

| Code Composer Studio™ IDE | IAR Embedded Workbench® IDE                                    |
|---------------------------|--|
| CCS v6.1 or later         | IAR Embedded Workbench for Texas Instruments 430 6.10 or later |

For more details on how to get started quickly, and where to download the latest CCS and IAR IDEs, see [Section 4](#).

### 3.1 Out-of-Box Software Example

This section describes the functionality and structure of the out-of-box software that is preloaded on the EVM.

There are two modes in the out-of-box software, stopwatch mode and temperature sensor mode, which can be controlled with S1 and S2 push buttons on the LaunchPad. This demo shows how to utilize the LCD\_C module, combined with the RTC counter, ADC, and internal temperature sensor, to implement simple stopwatch and thermometer.

### 3.1.1 Source File Structure

The project is split into multiple files. This makes it easier to navigate and reuse parts of it for other projects (see [Table 8](#)).

**Table 8. Source File and Folders**

| Name               | Description   |
|--------------------|---|
| main.c             | The out-of-box demo main function, initializations, shared ISRs, and other functions                                  |
| hal_LCD.c          | Hardware abstraction layer for LCD  |
| StopWatchMode.c    | Main function file for stopwatch mode   |
| TempSensorMode.c   | Main function file for live thermometer mode  |
| Library: Driverlib | Device driver library ( <a href="http://www.ti.com/tool/msp430driverlib">http://www.ti.com/tool/msp430driverlib</a> ) |

### 3.1.2 Power-up and Idle

Upon powering up the out-of-box demo, the LCD displays a scrolling welcome message. The MSP430FR6989 then enters a loop, in which the LCD cycles through all of its segments followed by a scrolling instruction message to "Hold S1 and S2 to switch modes".

### 3.1.3 Stopwatch Mode

While in the power up and idle state or in the temperature sensor mode, the stopwatch mode can be entered by holding down both S1 and S2 buttons shortly. The LCD displays scrolling text "STOPWATCH MODE" to indicate successful entry into this mode.

The MSP430FR6989 initializes the stopwatch calendar to HH:MM:SS:CC = 00:00:00:00, then goes to sleep in LPM3. Because the onboard LCD has six alphanumeric digits, the stopwatch format is initially MM:SS:CC, but will become HH:MM:SS when the timer reaches the first hour. This stopwatch counts up to 23h59m59s before resetting back to 00h00m00s.

By pressing the S1 button, the user can start the stopwatch timer (counts up). While the timer is running, the MSP430FR6989 sleeps and wakes between LPM3 (waiting for RTC interrupt) and active mode (incrementing calendar and updating LCD). Pressing the S1 button again will stop the stopwatch timer and returns the MSP430FR6989 back to LPM3 to conserve power. When the stopwatch timer is stopped, pressing S2 button will reset the timer back to 00:00:00.

While the stopwatch timer is running, pressing S2 button pauses the LCD at the current time but keeps the timer running in the background, allowing for the "Split timer" functionality. LCD can be resumed to the running timer by pressing S2 button again.

### 3.1.4 Temperature Sensor Mode

While inside the stopwatch mode, the temperature sensor mode can be entered by holding down both S1 and S2 buttons shortly. The LCD displays scrolling text "TEMPSENSOR MODE" to indicate successful entry into this mode.

Upon entering this mode, the MSP430FR6989 initializes the ADC input to its internal temperature sensor and starts sampling and conversion at four times per second. Each time an ADC conversion completes, the LCD shows the calculated temperature to the tenths decimal place.

The temperature unit can be toggled between Celsius and Fahrenheit by pressing the S2 button.

The temperature measurement can also be paused or resumed by pressing the S1 button. While the temperature measurement is running, the MSP430FR6989 sleeps and wakes between LPM3 (waiting for ADC sample and conversion to finish) and active mode (processing the results and updating LCD). When the temperature measurement is paused, the MSP430FR6989 enters LPM3 with the LCD remaining on, displaying the last measured temperature.

## 3.2 **Blink LED Example**

This very simple software example shows how to software toggle a GPIO to blink an LED on the LaunchPad.

### 3.2.1 **Source File Structure**

The project is split into multiple files. This makes it easier to navigate and reuse parts of it for other projects (see [Table 9](#)).

**Table 9. Source File and Folders**

| Name               | Description   |
|--------------------|---|
| main.c             | The Blink LED main function   |
| Library: Driverlib | Device driver library ( <a href="http://www.ti.com/tool/msp430driverlib">http://www.ti.com/tool/msp430driverlib</a> ) |

The main code utilizes the MSP430 Driver Library to halt the watchdog timer and to configure or toggle the GPIO pin connected to the LED inside a software loop.

## 4 **Resources**

### 4.1 **Integrated Development Environments**

Although the source files can be viewed with any text editor, more can be done with the projects if they are opened with a development environment like Code Composer Studio™ (CCS), IAR Embedded Workbench®, or Energia.

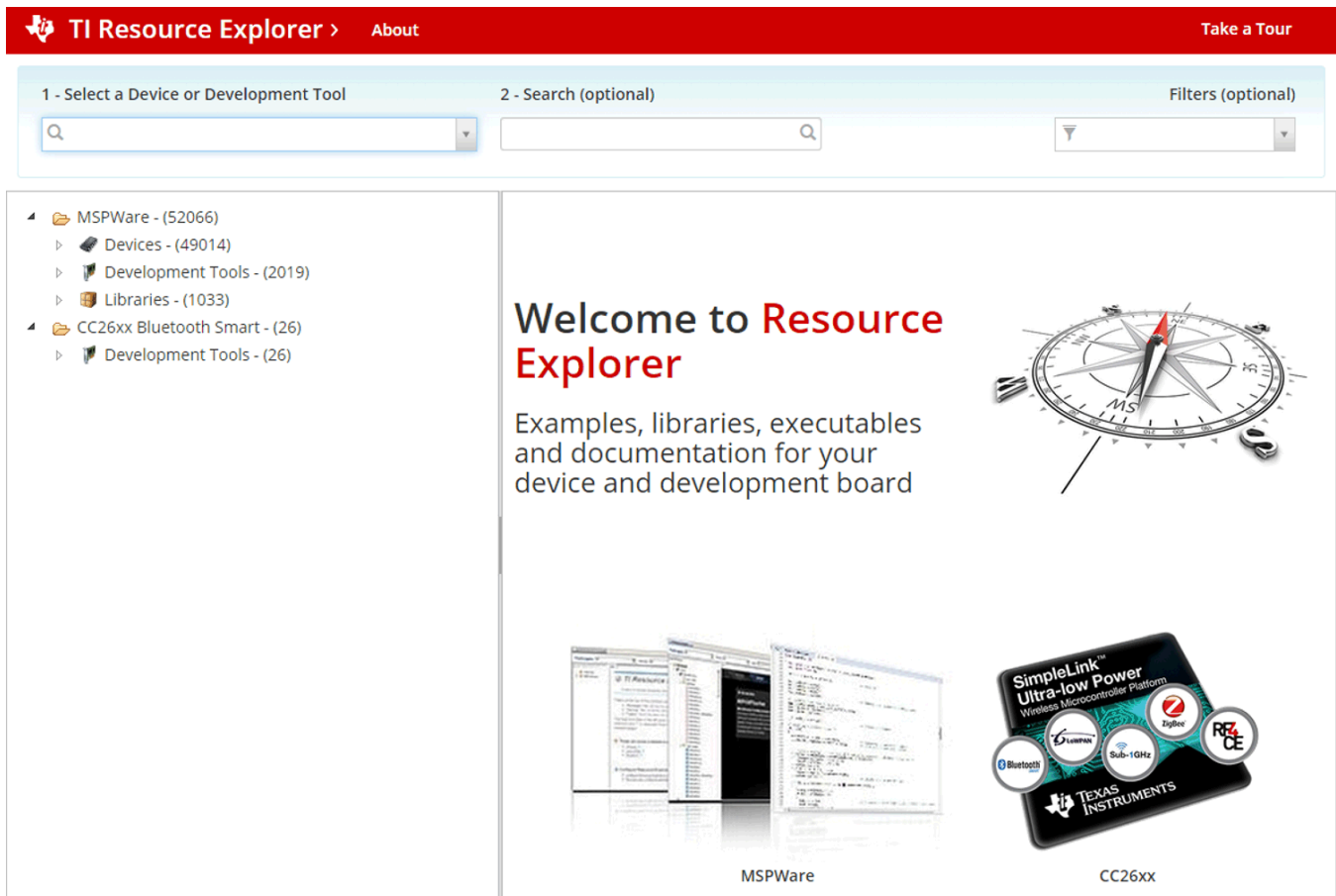
#### 4.1.1 **TI Cloud Development Tools**

TI's Cloud-based software development tools provide instant access to MSPWare content and a web-based IDE.

##### 4.1.1.1 **TI Resource Explorer Cloud**

TI Resource Explorer Cloud provides a web interface for browsing examples, libraries and documentation found in MSPWare without having to download files to your local drive (see [Figure 11](#)).

Go check out TI Resource Explorer Cloud now at <http://dev.ti.com>.



**Figure 11. TI Resource Explorer Cloud**

#### 4.1.1.2 Code Composer Studio Cloud

Code Composer Studio Cloud is a web-based IDE that allows code edit, compile and download to devices right from your web browser. It also integrates seamlessly with TI Resource Explorer Cloud with the ability to import projects directly on the cloud (see [Figure 12](#)).

Go check out Code Composer Studio Cloud now at <http://dev.ti.com>. A full comparison between CCS Cloud and CCS Desktop is available at this website.

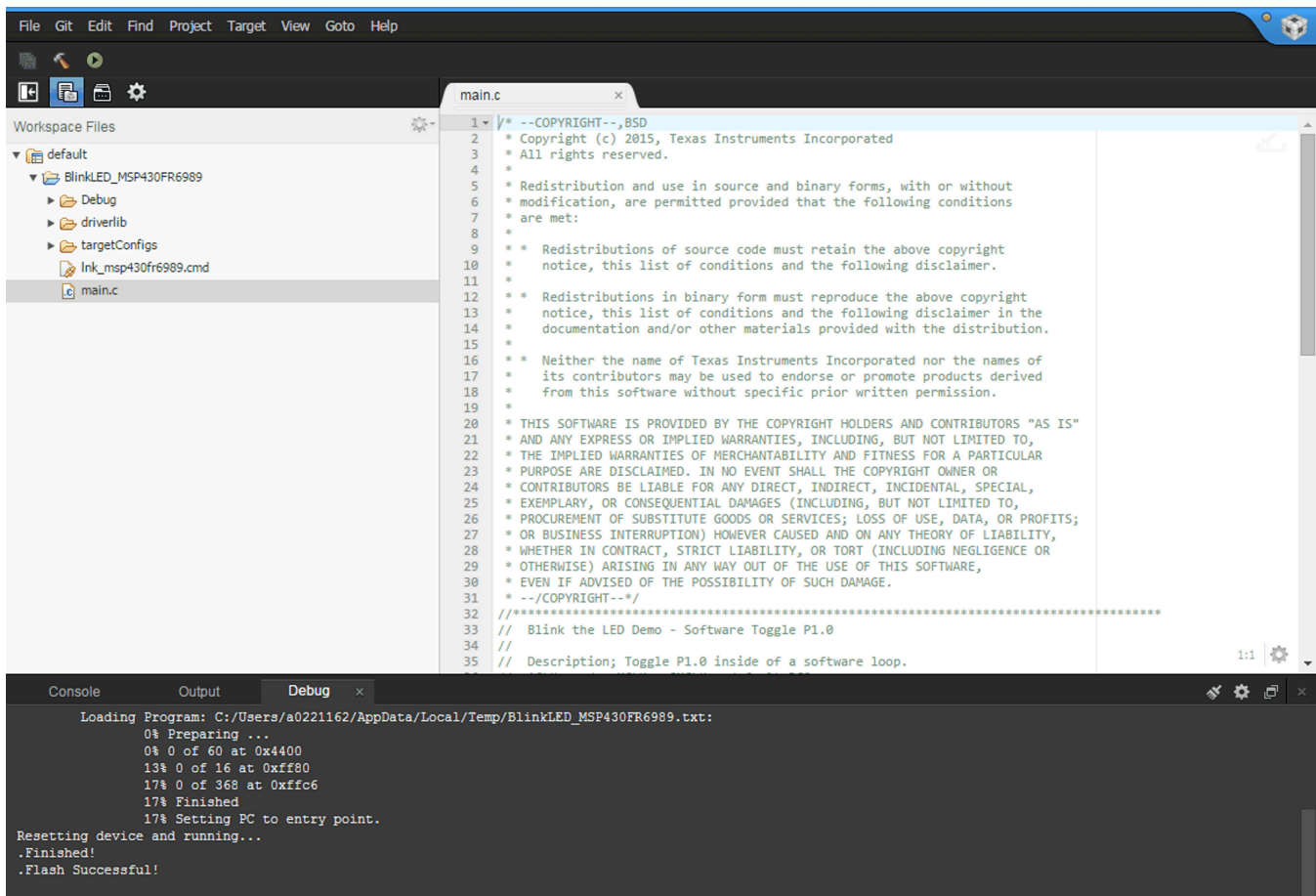


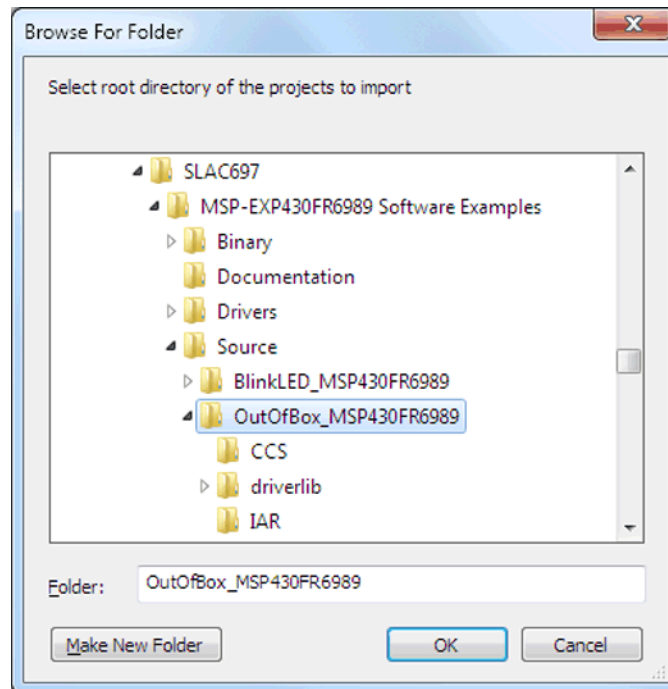
Figure 12. CCS Cloud

#### 4.1.2 Code Composer Studio

Code Composer Studio Desktop is a professional integrated development environment that supports TI's Microcontroller and Embedded Processors portfolio. Code Composer Studio comprises a suite of tools used to develop and debug embedded applications. It includes an optimizing C/C++ compiler, source code editor, project build environment, debugger, profiler, and many other features.

You can learn more about CCS and download it at <http://www.ti.com/tool/ccstudio>.

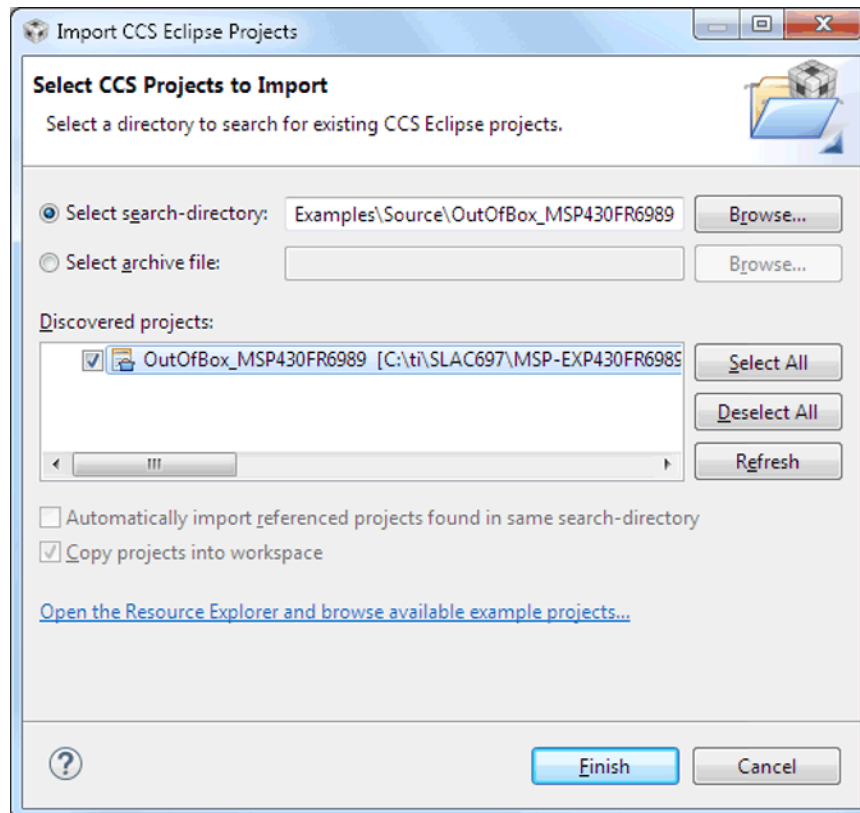
CCS v6.1 or higher is required. When CCS has been launched, and a workspace directory chosen, use Project>Import Existing CCS Eclipse Project. Direct it to the desired demo project directory that contains main.c (see Figure 13).



**Figure 13. Directing the Project>Import Function to the Demo Project**

Selecting the \CCS subdirectory also works. The CCS-specific files are located there.

When you click OK, CCS should recognize the project and allow you to import it. The indication that CCS has found it is that the project appears in the box shown in [Figure 14](#), and it has a checkmark to the left of it.



**Figure 14. When CCS Has Found the Project**

Sometimes CCS finds the project but does not show a checkmark; this might mean that your workspace already has a project by that name. You can resolve this by renaming or deleting that project. (Even if you do not see it in the CCS workspace, be sure to check the workspace directory on the file system.)

#### 4.1.3 IAR Embedded Workbench for Texas Instruments 430

IAR Embedded Workbench for ARM is another very powerful integrated development environment that allows you to develop and manage complete embedded application projects. It integrates the IAR C/C++ Compiler, IAR Assembler, IAR ILINK Linker, editor, project manager, command line build utility, and IAR C-SPY® Debugger.

You can learn more about IAR Embedded Workbench and download it at <https://www.iar.com/iar-embedded-workbench/arm>.

IAR 6.10 or higher is required. To open the demo in IAR, click File>Open>Workspace..., and browse to the \*.eww workspace file inside the \IAR subdirectory of the desired demo. All workspace information is contained within this file.

The subdirectory also has an \*.ewp project file. This file can be opened into an existing workspace by clicking Project>Add-Existing-Project....

Although the software examples have all of the code required to run them, IAR users may download and install MSP430Ware, which contains MSP430 libraries and the TI Resource Explorer. These are already included in a CCS installation (unless the user selected otherwise).



#### 4.1.4 Energia

Energia is a simple, open-source, and community-driven code editor that is based on the Wiring and Arduino framework. Energia provides unmatched ease of use through very high level APIs that can be used across hardware platforms. Energia is a light-weight IDE that does not have the full feature set of CCS or IAR. However, Energia is great for anyone who wants to get started very quickly or who does not have significant coding experience.

You can learn more about Energia and download it at <http://www.energia.nu>.

#### 4.2 LaunchPad Websites

More information about the LaunchPad kits, supported BoosterPack modules, and available resources can be found at:

- [MSP-EXP430FR6989](#) tool folder: resources specific to this particular LaunchPad
- TI's [LaunchPad portal](#): information about all LaunchPad kits from TI

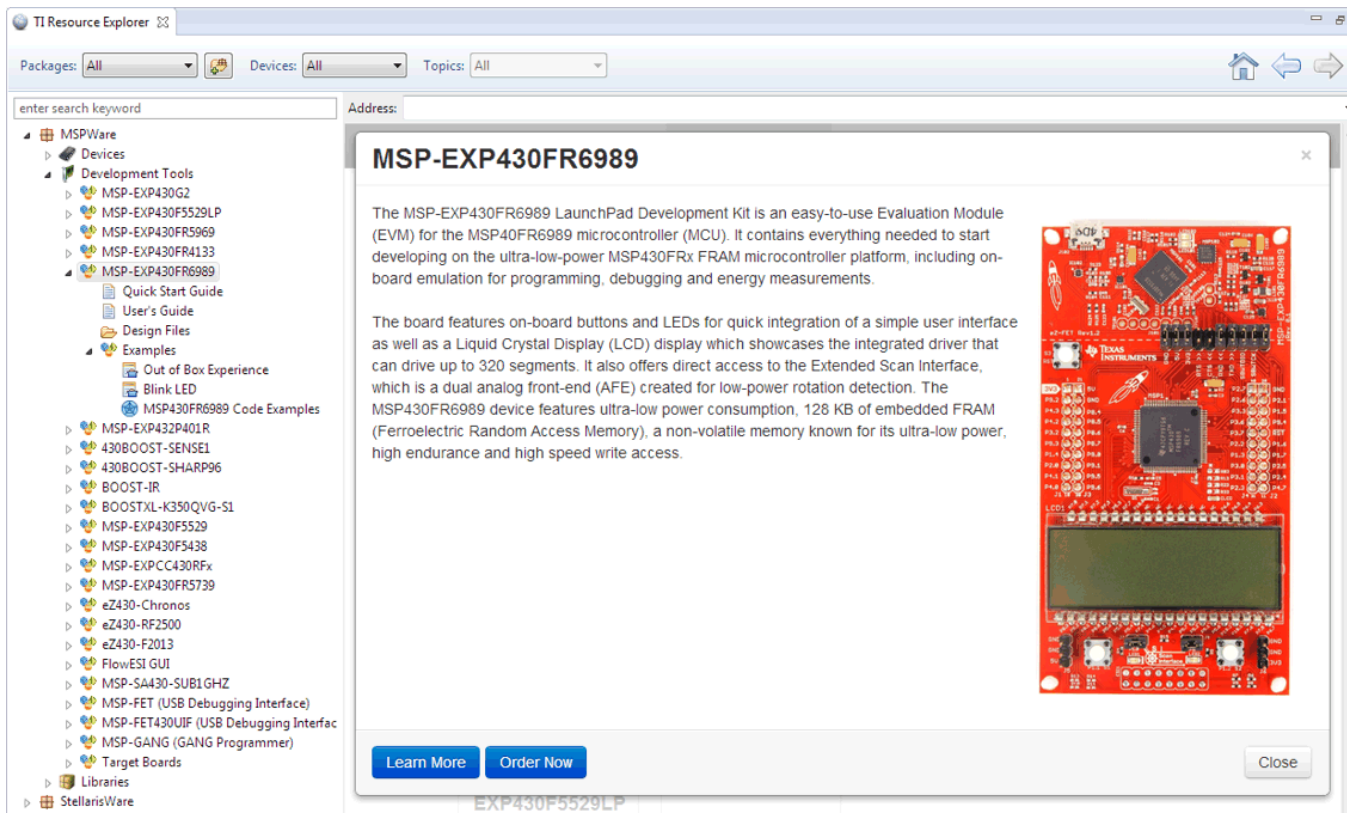
#### 4.3 MSPWare and TI Resource Explorer

TI Resource Explorer is a tool integrated into CCS that allows you to browse through available design resources. TI Resource Explorer will help you quickly find what you need inside packages including MSPWare, ControlSuite, TivaWare and more. TI Resource Explorer is well organized to find everything that you need quickly, and you can import software projects into your workspace in one click!

TI Resource Explorer Cloud is one of the TI Cloud Development tools, and is tightly integrated with CCS Cloud. See [Section 4.1.1](#) for more information.

MSPWare is a collection of code examples, software libraries, data sheets and other design resources for ALL MSP devices delivered in a convenient package – essentially everything developers need to become MSP experts!

In addition to providing a complete collection of existing MSP design resources, MSPWare also includes a high level API called MSP Driver Library. This library makes it easy to talk to MSP hardware. More information can be found at <http://www.ti.com/tool/mspware>.



**Figure 15. Using TI Resource Explorer to Browse MSP-EXP430FR6989 in MSPWare**

Inside TI Resource Explorer, these examples and many more can be found, and easily imported into CCS with one click.

#### 4.4 FRAM Utilities

The TI [FRAM Utilities](#) is a collection of embedded software utilities that leverage the ultra-low-power and virtually unlimited write endurance of FRAM. The utilities are available for MSP430FRxx FRAM microcontrollers and provide example code to help start application development.

##### 4.4.1 Compute Through Power Loss

Compute Through Power Loss is a utility API set that enables ease of use with LPMx.5 low-power modes and a powerful shutdown mode that allows an application to save and restore critical system components when a power loss is detected.

## 4.5 MSP430FR6989

### 4.5.1 Device Documentation

At some point, you will probably want more information about the MSP430FR6989 device. For every MSP device, the documentation is organized as shown in [Table 10](#).

**Table 10. How MSP Device Documentation is Organized**

| Document                   | For MSP430FR6989   | Description   |
|----------------------------|--|---|
| Device family user's guide | <a href="#">MSP430FR58xx, MSP430FR59xx, MSP430FR68xx, and MSP430FR69xx Family User's Guide</a> | Architectural information about the device, including all modules and peripherals such as clocks, timers, ADC, and so on. |
| Device-specific data sheet | <a href="#">MSP430FR698x(1), MSP430FR598x(1) Mixed-Signal Microcontrollers data sheet</a>      | Device-specific information and all parametric information for this device  |

### 4.5.2 MSP430FR6989 Code Examples

[MSP430FR5x8x, MSP430FR692x, MSP430FR6x7x, MSP430FR6x8x Code Examples](#) is a set of very simple C examples that demonstrate how to use the entire set of MSP430 peripherals (including, serial communication, ADC12, LCD\_C, Timer\_A, Timer\_B, and others) through direct register access.

Every MSP derivative has a set of these code examples. When starting a new project or adding a new peripheral, these examples serve as a great starting point.

### 4.5.3 MSP430 Application Notes and TI Designs

There are many application notes that can be found at <http://www.ti.com/msp430>, in addition to TI Designs with practical design examples and topics.

## 4.6 Community Resources

### 4.6.1 TI E2E™ Community

Search the forums at [e2e.ti.com](http://e2e.ti.com). If you cannot find your answer, post your question to the community!

### 4.6.2 Community at Large

Many online communities focus on the LaunchPad – for example, <http://www.43oh.com>. You can find additional tools, resources, and support from these communities.

## 5 FAQs

### **Q: I can't get the backchannel UART to connect. What's wrong?**

A: Check the following:

- Do the baud rate in the host terminal application and the eUSCI settings match?
- Are the appropriate jumpers in place on the isolation jumper block?
- Probe on RXD and send data from the host. If you don't see data, it might be a problem on the host side.
- Probe on TXD while sending data from the MSP. If you don't see data, it might be a configuration problem with the eUSCI module.
- Consider the use of the hardware flow control lines (especially for higher baud rates).

### **Q: Is this the same LCD as the MSP430FR4133 LaunchPad?**

A: Yes, this is the exact same LCD. However, there are two differences: the physical pin connections to the LCD and the LCD module in the MSP devices themselves. The MSP430FR4133 device has the LCD\_E module, while the MSP430FR6989 has the LCD\_C module. See the application note [Designing with MSP430 MCUs and Segment LCDs](#) for more information on the differences between the LCD modules.

### **Q: Can I purchase the ESI plug-in boards separately from TI?**

A: These plug-in boards only come with the [EVM430-FR6989](#) EVM, however, all design files are made available for you to create your own. See the associated TI Design [TIDM-LC-WATERMTR](#) for hardware design resources and Gerber files.

### **Q: The MSP G2 LaunchPad had a socket, allowing me change the target device. Why doesn't this LaunchPad use one?**

A: This LaunchPad provides more functionality, and this means using a device with more pins. Sockets for devices with this many pins are too expensive for the LaunchPad target price.

6 Schematics

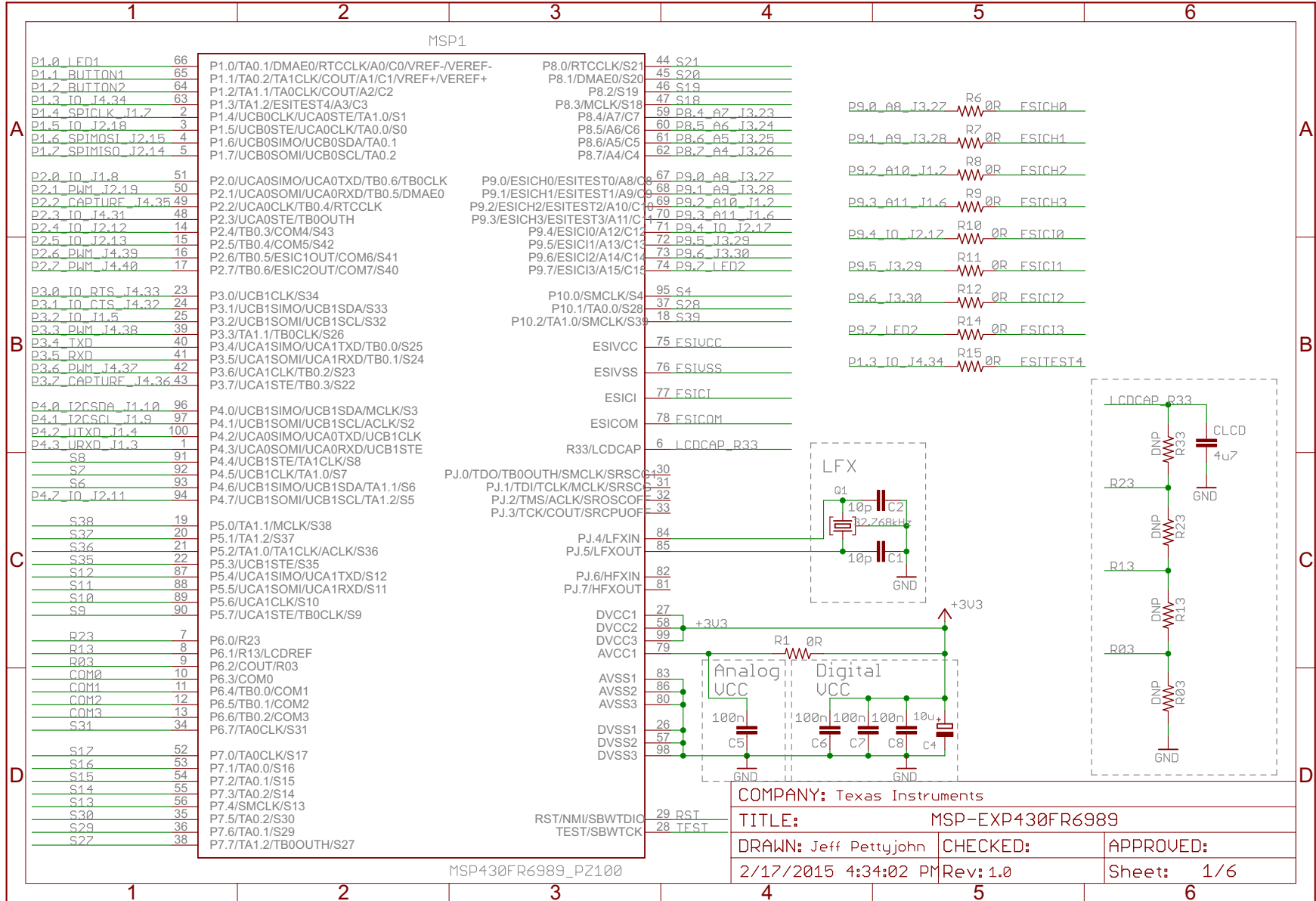


Figure 16. Schematics (1 of 6)

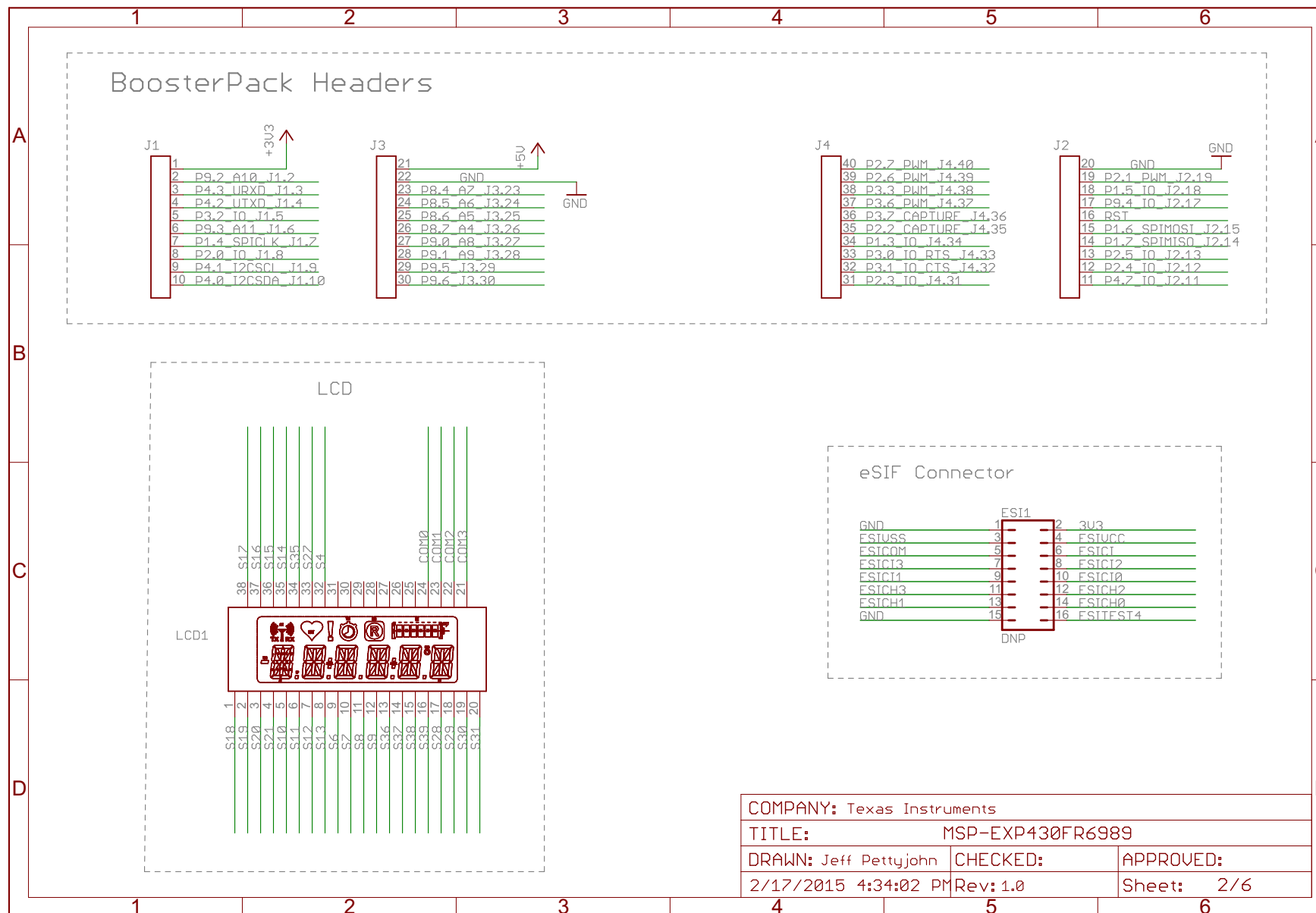


Figure 17. Schematics (2 of 6)

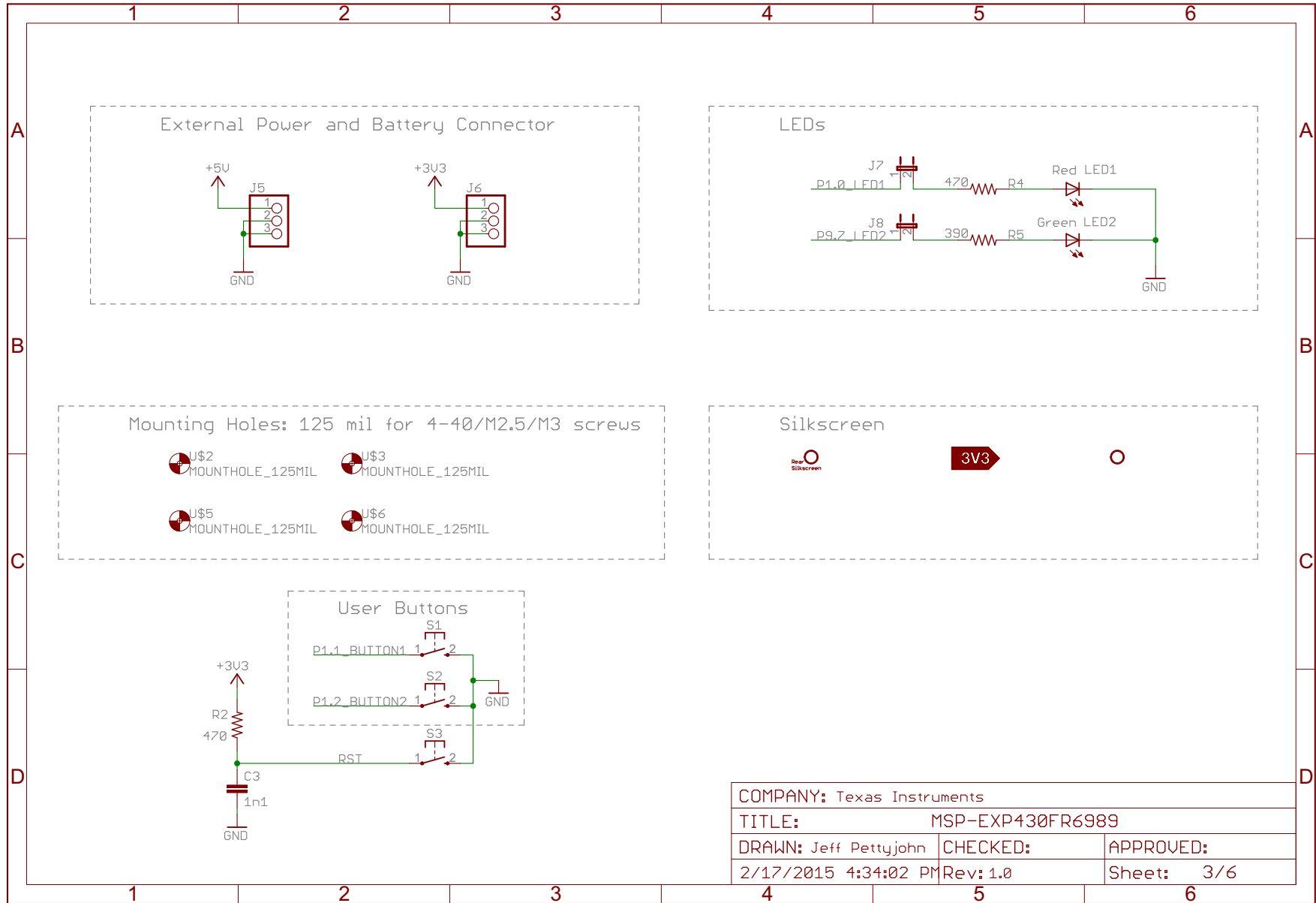


Figure 18. Schematics (3 of 6)

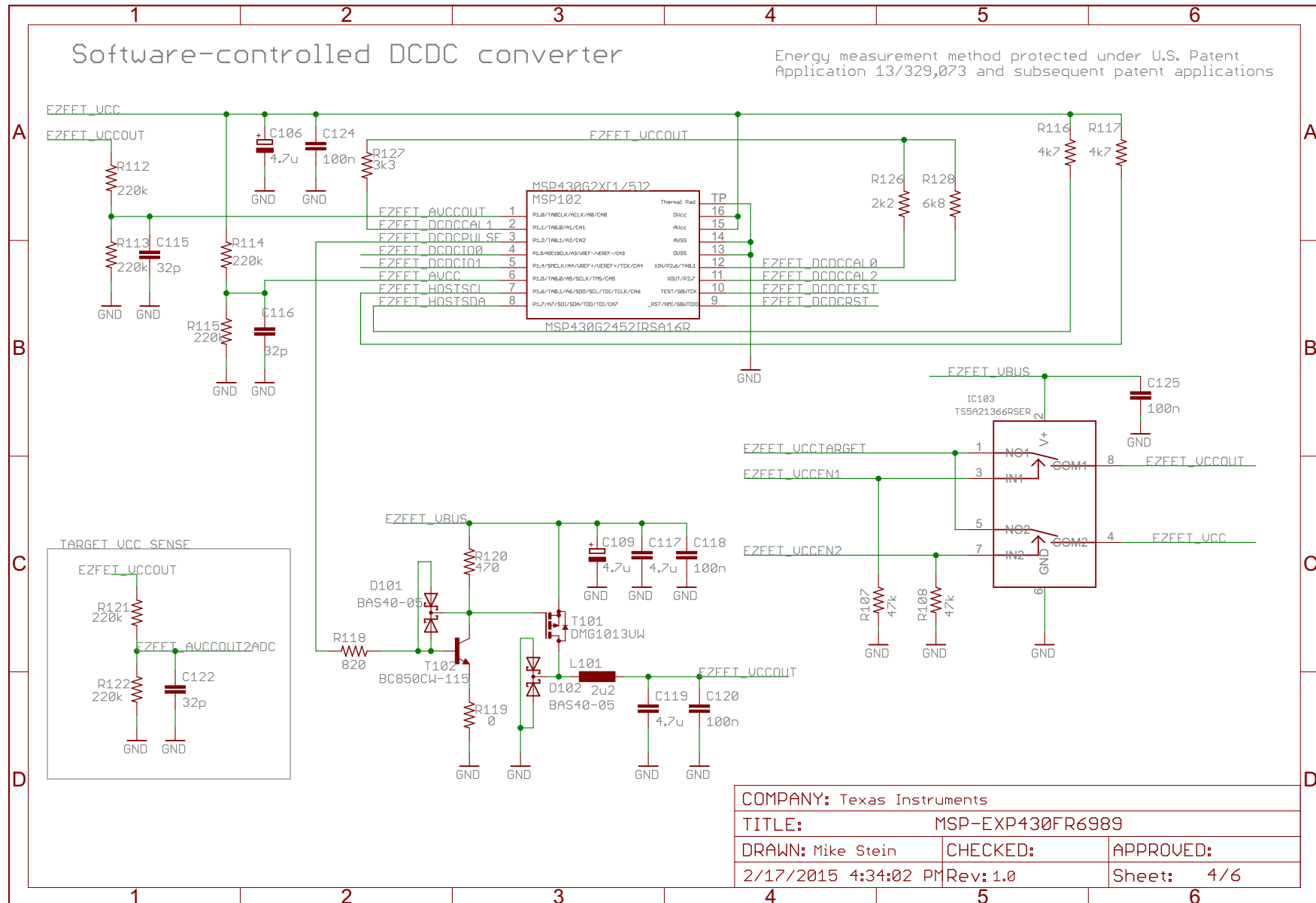


Figure 19. Schematics (4 of 6)



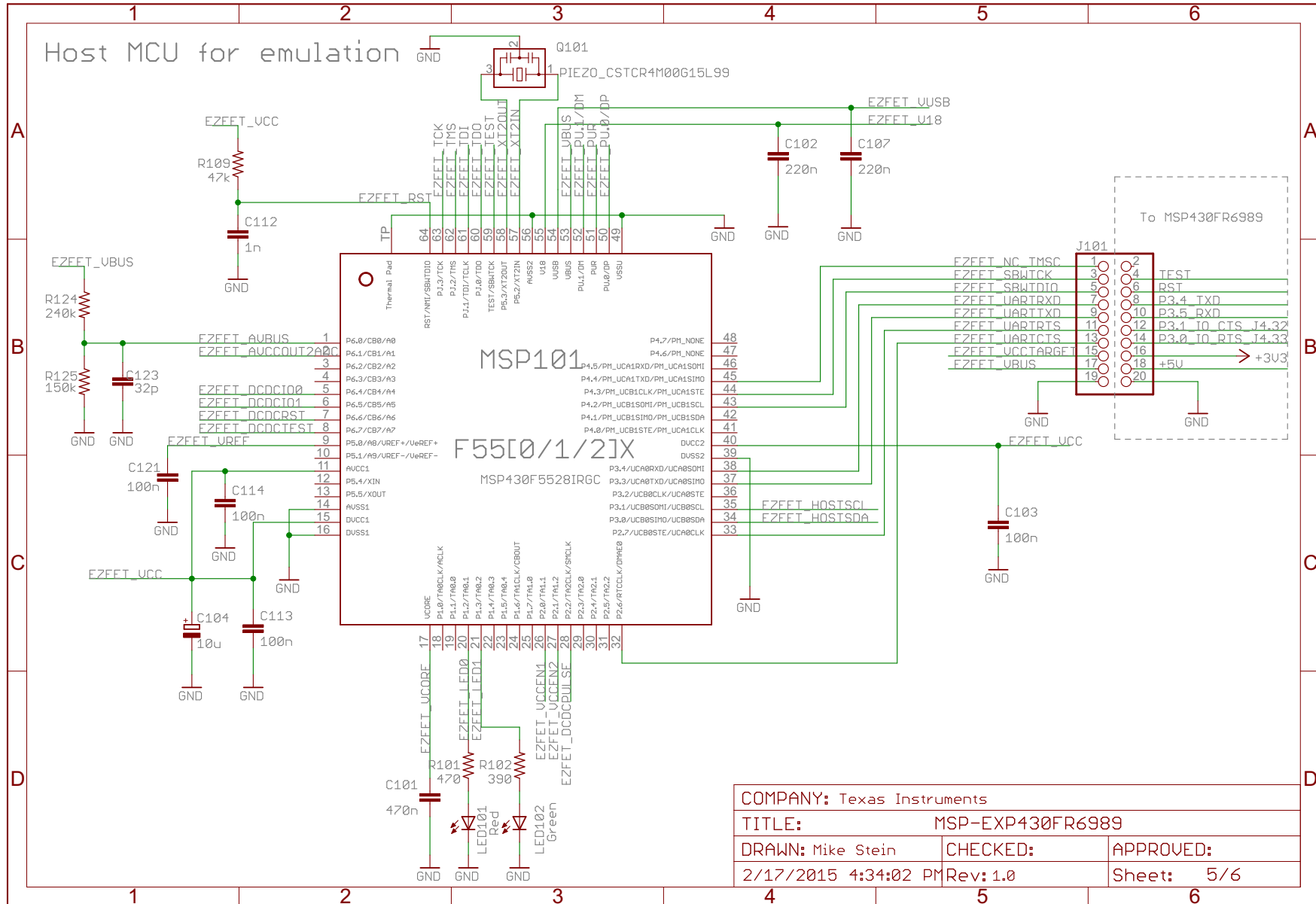


Figure 20. Schematics (5 of 6)

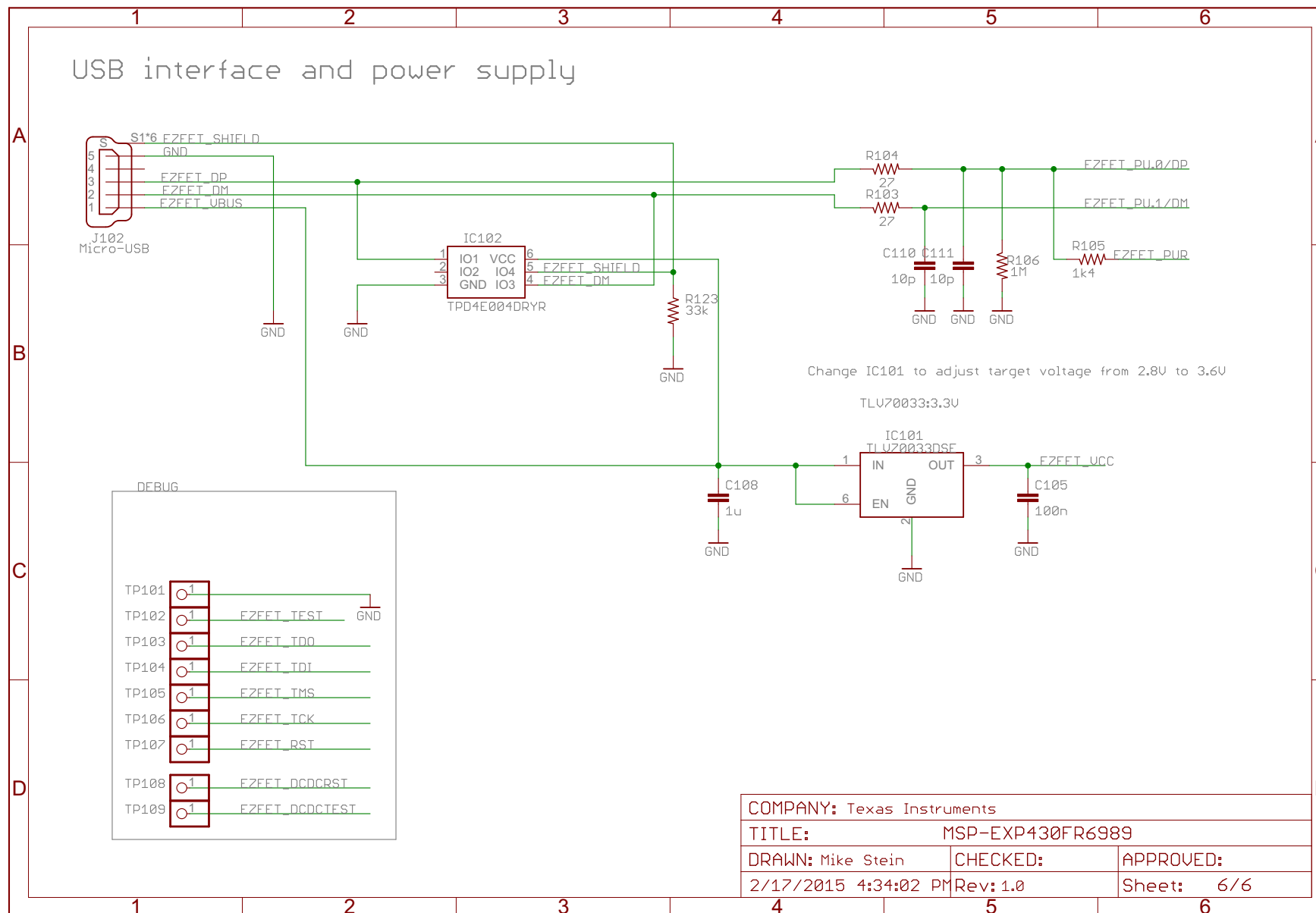


Figure 21. Schematics (6 of 6)

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## Revision History

**Changes from May 9, 2015 to July 20, 2015****Page**

- 
- Throughout the document, changed the link destinations for the *MSP-EXP430FR6989 Hardware Design Files* and the *MSP-EXP430FR6989 Software Examples* ..... 1
- 

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
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